# **E9XA** Automotive surface mount crystal resonator MHz



Photo is representative

### **Product features**

- · 0806 (2016 metric) package
- Moisture sensitivity level (MSL): 1
- · AEC-Q200
- Frequency range 16 MHz to 50 MHz
- Variety of frequency tolerance and stability options

### Applications

- Tire-pressure monitoring system (TPMS)
- · Remote keyless entry (RKE)
- Front lighting system
- ADAS
- · Camera/radar system
- · In-vehicle infotainment (IVI)
- Car audio
- Battery management systems (BMS)

### Environmental compliance and general specifications

- Operating temperature range: -40 °C to +125 °C
- Storage temperature range (component): -40 °C
- to +125 ℃





### Part number system

E	9	x	260	08	1	z	A1
	Size code	Product category	Frequency	Load capacitance	Frequency tolerance	Frequency stability	Internal code
E = Eaton	9 = 2016 metric, 0806 imperial	X = crystal	260 = 26 MHz	08 = 8 pF 10 = 10 pF 12 = 12 pF	$1 = \pm 10 \text{ ppm}$ $7 = \pm 15 \text{ ppm}$ $2 = \pm 20 \text{ ppm}$ $4 = \pm 30 \text{ ppm}$ $5 = \pm 50 \text{ ppm}$	Z = ±50 ppm Q = ±100 ppm	(A1 - A9, AA - AZ without I&O) for automotive

### **Electrical specifications**

Items	Parameters		
Frequency range	16 MHz to 50 MHz		
Oscillation mode	Fundamental		
Frequency tolerance at +25 °C	±10, ±15, ±20, ±30, ±50 ppm		
Frequency stability vs. operating temperature range	See table below		
Equivalent series resistance	See table below		
Drive level	10, 100, 200 μW or specify		
Insulation resistance	500 $M\Omega$ minimum at 100 Vdc		
Load capacitance	8, 10, 12 pF or specify		
Shunt capacitance (CO)	3 pF maximum or specify		
Aging at +25 °C	±3 ppm (first year)		

### Frequency stability vs. operating temperature range table

ppm	±50	±100
Operating temperature -40 °C to +125 °C	х	х

### Equivalent series resistance table

Frequency (MHz)	ESR (Ω) maximum	Oscillation mode
16 ≤ f < 20	120	
20 ≤ f < 32	80	Fundamental
$32 \le f \le 50$	50	

### Construction



	Description
Cap (lid)	Kovar (Fe-Ni-Co)
Base (package)	Almina Ceramic (Al <sub>2</sub> 0 <sub>3</sub> )
Pad (package)	Ni + Au
Crystal blank	SiO <sub>2</sub>
Conductive adhesive	Ag
Electrode	Cr + Au
	Cap (lid)   Base (package)   Pad (package)   Crystal blank   Conductive adhesive   Electrode

### **Dimensions** -mm





## - 0.55±0.10 #4 #1 -0.70±0.10

### Pad layout -mm



Tolerance unless otherwise specified: ±0.1 mm

### **Function diagram**



Pad	Function
1	ln / out
2	Ground
3	Out / in
4	Ground

### Part marking



### Packaging information - mm

3,000 parts on a 7 inch tape and reel (Drawing not to scale)



AD



B0

Dimension	Millimeter
W	8.00 ± 0.30
F	3.50 ± 0.05
E1	1.75 ± 0.10
PO	4.00 ± 0.10
P1	4.00 ± 0.10
P2	2.00 ± 0.05
DO	1.55 ± 0.05
D1	1.00 minimum
A0	1.90 ± 0.10
B0	2.30 ± 0.10
KO	0.65 ± 0.10
Т	0.25 ± 0.05
T2	1.15 maximum

### Solder reflow profile



#### Table 1 - Standard SnPb solder (T<sub>c</sub>)

C Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T<sub>c</sub>)

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

#### **Reference J-STD-020**

Profile feature	Standard SnPb solder	Lead (Pb) free solder	
Preheat and soak • Temperature min. (T <sub>smin</sub> )	100 °C	150 °C	
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds	
Ramp up rate TL to Tp	3 °C/ second max.	3 °C/ second max.	
Liquidous temperature (TL) Time (tL) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body temperature (T <sub>P</sub> )*	Table 1	Table 2	
Time $(t_p)^*$ within 5 °C of the specified classification temperature $(T_c)$	20 seconds*	30 seconds*	
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/ second max.	6 °C/ second max.	
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.	

 $^{\ast}$  Tolerance for peak profile temperature (T\_p) is defined as a supplier minimum and a user maximum.

### Manual solder

+350 °C maximum, 4 seconds maximum by soldering iron, 2 times maximum, generally manual, hand soldering is not recommended

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